# 2A, 36V DC/DC Step-Down $\mu$ Module Regulator 

## feATURES

- Complete Step-Down Switch Mode Power Supply
- Wide Input Voltage Range: 3.6V to 36V
- 2A Output Current
- 0.8 V to 10 V Output Voltage
- Selectable Switching Frequency: 200kHz to 2.4MHz
- Current Mode Control
- Programmable Soft-Start
- SnPb (BGA) or RoHS Compliant (LGA and BGA) Finish
- Tiny, Low Profile, Surface Mount LGA (9mm × $11.25 \mathrm{~mm} \times 2.82 \mathrm{~mm}$ ) and BGA $(9 \mathrm{~mm} \times 11.25 \mathrm{~mm} \times$ 3.42 mm ) Packages


## APPLICATIONS

- Automotive Battery Regulation
- Power for Portable Products
- Distributed Supply Regulation
- Industrial Supplies
- Wall Transformer Regulation


## DESCRIPTIOn

The LTM ${ }^{\circledR} 8023$ is a complete $2 \mathrm{~A}, \mathrm{DC} / \mathrm{DC}$ step-down power supply. Included in the package are the switching controller, power switches, inductor, and all support components. Operating over an input voltage range of 3.6 V to 36 V , the LTM8023 supports an output voltage range of 0.8 V to 10 V , and a switching frequency range of 200 kHz to 2.4 MHz , each set by a single resistor. Only the bulk input and output filter capacitors are needed to finish the design.
The low profile package enables utilization of unused space on the bottom of PC boards for high density point of load regulation.

The LTM8023 is packaged in a thermally enhanced, compact and low profile over-molded land grid array (LGA) and ball grid array (BGA) packages suitable for automated assembly by standard surface mount equipment. The LTM8023 is available with SnPb (BGA) or RoHS compliant terminal finish.
$\boldsymbol{\Sigma T}$, LT, LTC, LTM, Linear Technology, the Linear logo, Burst Mode and $\mu$ Module are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners.

## TYPICAL APPLICATION

$5.5 \mathrm{~V}_{\text {IN }}$ to $36 \mathrm{~V}_{\text {IN }}, 3.3 \mathrm{~V} / 2 \mathrm{~A} \mathrm{DC/DC} \mathrm{\mu Module}{ }^{\ominus}$ Converter


Efficiency and Power Loss

absolute maximum ratings
(Note 1)
Vin, RUN/SS Voltage ..... 40V
$\mathrm{V}_{\text {IN }}+\mathrm{BIAS}$ ..... 56V
ADJ, $R_{T}$, SHARE Voltage ..... 5 V
Vout, AUX ..... 10V
PGOOD, SYNC ..... 30V
BIAS ..... 16 V
Internal Operating Temperature
(Note 2) ..... $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Storage Temperature. ..... $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Solder Temperature. ..... $250^{\circ} \mathrm{C}$
pIn COnfiguration


## ORDER INFORMATION

| PART NUMBER | PAD OR BALL FINISH | PART MARKING* |  | PACKAGE TYPE | MSLRATING | TEMPERATURE RANGE (Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | DEVICE | FINISH CODE |  |  |  |
| LTM8023EV\#PBF | Au (RoHS) | LTM8023V | e4 | LGA | 3 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTM8023IV\#PBF | Au (RoHS) | LTM8023V | e4 | LGA | 3 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTM8023MPV\#PBF | Au (RoHS) | LTM8023MPV | e4 | LGA | 3 | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |
| LTM8023EY\#PBF | SAC305 (RoHS) | LTM8023Y | e1 | BGA | 3 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTM8023IY\#PBF | SAC305 (RoHS) | LTM8023Y | e1 | BGA | 3 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTM8023IY | SnPb (63/37) | LTM8023Y | e0 | BGA | 3 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTM8023MPY\#PBF | SAC305 (RoHS) | LTM8023Y | e1 | BGA | 3 | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |
| LTM8023MPY | SnPb (63/37) | LTM8023Y | e0 | BGA | 3 | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |

Consult Marketing for parts specified with wider operating temperature ranges. *Device temperature grade is indicated by a label on the shipping container. Pad or ball finish code is per IPC/JEDEC J-STD-609.

- Terminal Finish Part Marking: www.linear.com/leadfree
- Recommended LGA and BGA PCB Assembly and Manufacturing Procedures: www.linear.com/umodule/pcbassembly
- LGA and BGA Package and Tray Drawings: www.linear.com/packaging


## ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating

 temperature range, otherwise specifications are at $T_{A}=25^{\circ} \mathrm{C} . \mathrm{V}_{I N}=10 \mathrm{~V}, \mathrm{~V}_{\text {RUN/SS }}=10 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}=3 \mathrm{~V}, \mathrm{R}_{\mathrm{T}}=60.4 \mathrm{k}, \mathrm{C}_{\text {OUT }}=4.7 \mathrm{FF}$ unless otherwise specified.| SYMBOL | PARAMETER | CONDITIONS |  | MII | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IN }}$ | Input DC Voltage |  | $\bullet$ | 3.6 |  | 36 | V |
| Vout | Output DC Voltage | $\begin{aligned} & 0 \mathrm{~A}<\mathrm{I}_{\text {OUT }} \leq 2 \mathrm{~A}, \mathrm{R}_{\text {ADJ }} \text { Open, } \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}(\text { Note 3) } \\ & 0 \mathrm{~A}<\mathrm{I}_{\text {OUT }} \leq 2 \mathrm{~A}, \mathrm{R}_{\text {ADJ }}=43.2 \mathrm{k}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F} \text { (Note 3) } \end{aligned}$ |  |  | $\begin{aligned} & 0.8 \\ & 10 \end{aligned}$ |  | V |
| $\mathrm{R}_{\text {ADJ(MIN) }}$ | Minimum Allowable R RADJ | (Note 4) |  | 42.2 |  |  | k $\Omega$ |
| IOUT | Continuous Output DC Current | $4 \leq \mathrm{V}_{\text {IN }} \leq 36, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  | 0 |  | 2 | A |
| $\mathrm{IQ}_{\text {VIN }}$ | $V_{\text {IN }}$ Quiescent Current | $V_{\text {RUN/SS }}=0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{T}}=174 \mathrm{k}$ <br> $V_{\text {BIAS }}=3 \mathrm{~V}$, Not Switching, $\mathrm{R}_{\mathrm{T}}=174 \mathrm{k}(\mathrm{E}, \mathrm{I})$ <br> $V_{\text {BIAS }}=3 \mathrm{~V}$, Not Switching, $\mathrm{R}_{\mathrm{T}}=174 \mathrm{k}$ (MP) <br> $V_{\text {BIAS }}=0 V$, Not Switching, $R_{T}=174 \mathrm{k}$ | $\bullet$ |  | $\begin{aligned} & 0.1 \\ & 25 \\ & 25 \\ & 85 \end{aligned}$ | $\begin{gathered} \hline 0.5 \\ 60 \\ 350 \\ 120 \end{gathered}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $1 Q_{\text {BIAS }}$ | BIAS Quiescent Current | $V_{\text {RUN/SS }}=0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{T}}=174 \mathrm{k}$ <br> $V_{\text {BIAS }}=3 V$, Not Switching, $R_{T}=174 \mathrm{k}(\mathrm{E}, \mathrm{I})$ <br> $V_{\text {BIAS }}=3 \mathrm{~V}$, Not Switching, $\mathrm{R}_{\mathrm{T}}=174 \mathrm{k}$ (MP) <br> $V_{B I A S}=0 V$, Not Switching, $R_{T}=174 \mathrm{k}$ | $\bullet$ |  | $\begin{gathered} 0.03 \\ 50 \\ 50 \\ 1 \\ \hline \end{gathered}$ | $\begin{gathered} 0.5 \\ 120 \\ 200 \\ 5 \\ \hline \end{gathered}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $\triangle \mathrm{V}_{\text {OUT }} / V_{\text {OUT }}$ | Line Regulation | $5 \leq \mathrm{V}_{\text {IN }} \leq 36, \mathrm{I}_{\text {OUT }}=1 \mathrm{~A}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  | 0.1 |  | \% |
| $\Delta \mathrm{V}_{\text {OUT }} / V_{\text {OUT }}$ | Load Regulation | $\mathrm{V}_{\text {IN }}=24 \mathrm{~V}, 0 \leq \mathrm{I}_{\text {OUT }} \leq 2 \mathrm{~A}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  | 0.4 |  | \% |
| $\mathrm{V}_{\text {OUT(AC_RMS }}$ | Output Ripple (RMS) | $\mathrm{V}_{\text {IN }}=24 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=2 \mathrm{~A}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  | 10 |  | mV |
| $\mathrm{f}_{\text {SW }}$ | Switching Frequency | $\mathrm{R}_{\mathrm{T}}=113 \mathrm{k}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  | 325 |  | kHz |
| $\underline{\mathrm{ISC}}$ (OUT) | Output Short Circuit Current | $\mathrm{V}_{\text {IN }}=36 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}$ (Note 5) |  |  | 2.9 |  | A |
| $\mathrm{V}_{\text {ADJ }}$ | Voltage at ADJ Pin | $\mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ | $\bullet$ | 765 | 790 | 805 | mV |
| $\mathrm{V}_{\text {BIAS(MIN) }}$ | Minimum BIAS Voltage for Proper Operation |  |  |  | 2.3 | 2.8 | V |
| $\underline{I A D J}$ | Current Out of ADJ Pin | ADJ $=1 \mathrm{~V}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  | 2 |  | $\mu \mathrm{A}$ |
| $\underline{\text { IRUN/SS }}$ | RUN/SS Pin Current | $\mathrm{V}_{\text {RUN/SS }}=2.5 \mathrm{~V}$ |  |  | 5 | 10 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {IH(RUN/SS) }}$ | RUN/SS Input High Voltage | $\mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  | 2.5 |  |  | V |
| $\mathrm{V}_{\text {IL(RUN/SS) }}$ | RUN/SS Input Low Voltage | $\mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  |  | 0.2 | V |
| VPGOOD (TH) | PGOOD Threshold | $\mathrm{V}_{\text {Out }}$ Rising |  |  | 730 |  | mV |
| IPGOOD(0) | PGOOD Leakage | $V_{\text {PGOOD }}=30 \mathrm{~V}$ |  |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| IPGOOD(SINK) | PGOOD Sink Current | $V_{\text {PGOOD }}=0.4 \mathrm{~V}$ |  | 200 | 800 |  | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {SYNCIL }}$ | SYNC Input Low Threshold | $\mathrm{f}_{\text {SYNC }}=550 \mathrm{kHz}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  |  |  | 0.5 | V |
| $\mathrm{V}_{\text {SYNCIH }}$ | SYNC Input High Threshold | $\mathrm{f}_{\text {SYNC }}=550 \mathrm{kHz}, \mathrm{C}_{\text {OUT }}=51 \mu \mathrm{~F}$ |  | 0.7 |  |  | V |
| $\underline{\text { ISYNCBIAS }}$ | SYNC Pin Bias Current | $\mathrm{V}_{\text {SYNC }}=0 \mathrm{~V}$ |  |  | 0.1 |  | $\mu \mathrm{A}$ |

Note 1: Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.
Note 2: The LTM8023E is guaranteed to meet performance specifications from $0^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ ambient. Specifications over the full $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ ambient operating temperature range are assured by design, characterization and correlation with statistical process controls. The LTM80231 is guaranteed to meet specifications over the full $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ ambient operating temperature range. The LTM8023MP is guaranteed to
meet specifications over the full $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ temperature range. Note that the maximum internal temperature is determined by specific operating conditions in conjunction with board layout, the rated package thermal resistance and other environmental factors.
Note 3: Cout $=51 \mu \mathrm{~F}$ is composed of a $4.7 \mu \mathrm{~F}$ ceramic capacitor in parallel with a $47 \mu \mathrm{~F}$ electrolytic.
Note 4: Guaranteed by design.
Note 5: Short circuit current at $\mathrm{V}_{\mathbb{I N}}=36 \mathrm{~V}$ is guaranteed by characterization and correlation. $100 \%$ tested at $V_{I N}=10 \mathrm{~V}$

TYPICAL PERFORMANCE CHARACTERISTICS $T_{A}=25^{\circ}$ c unless oliemisise noted




Input Current vs Output Current



## $36 V_{\text {IN }}$ Start-Up Waveforms

( $5 \mathrm{~V}_{\text {OUT }}$ )



Efficiency (3.3V $\mathrm{V}_{\text {OUT }}$ )

$36 V_{\text {IN }}$ Start-Up Waveforms (3.3V $\mathrm{V}_{\text {OUT }}$ )



## TYPICAL PGRFORMAOCE CHARACTERISTICS $T_{A}=25^{\circ} \mathrm{C}$ unless otherwise noted






TYPICAL PGRFORMAOCE CHARACTERISTICS $T_{A}=25^{\circ} \mathrm{Culless}$ otherwise noted


$8 \mathrm{~V}_{\text {OUT }}$ Temperature Rise vs Load Current (BGA)


## PIn fUnCTIOnS

$V_{\text {IN }}$ (Bank 1): The $\mathrm{V}_{\text {IN }}$ pin supplies current to the LTM8023's internal regulator and to the internal power switch. This pin must be locally bypassed with an external, low ESR capacitor of at least $2.2 \mu \mathrm{~F}$.
$\mathbf{V}_{\text {OUT }}$ (Bank 2): Power Output Pins. Apply the output filter capacitor and the output load between these pins and GND pins.

AUX (Pin F5): Low Current Voltage Source for BIAS. The $V_{\text {AUX }}$ pin is internally connected to $V_{\text {OUT }}$ and is placed adjacent to the BIAS pin to ease printed circuit board routing. Although this pin is internally connected to $\mathrm{V}_{\text {OUT }}$, do NOT connect this pin to the load. If this pin is not tied to BIAS, leave it floating.
BIAS (Pin G5): The BIAS pin connects to the internal power bus. Connect to a power source greater than 2.8 V . If the output is greater than 2.8 V , connect this pin there. If the output voltage is less, connect this to a voltage source between 2.8 V and 16 V . Also, make sure that BIAS $+\mathrm{V}_{\text {IN }}$ is less than 56V.

RUN/SS (Pin H5): Tie RUN/SS pin to ground to shut down the LTM8023. Tie to 2.5 V or more for normal operation. If the shutdown feature is not used, tie this pin to the $V_{\text {IN }}$ pin. RUN/SS also provides a soft-start function; see the Applications Information section.

GND (Bank 3): Tie these GND pins to a local ground plane below the LTM8023 and the circuit components. In most applications, the bulk of the heat flow out of the LTM8023 is through these pads, so the printed circuit design has a
large impact on the thermal performance of the part. See the PCB Layout and Thermal Consideration sections for more details. Return the feedback divider ( $\mathrm{R}_{\text {ADJ }}$ ) to this net.
$\mathbf{R}_{\boldsymbol{T}}$ (Pin G7): The $\mathrm{R}_{\boldsymbol{\top}}$ pin is used to program the switching frequency of the LTM8023 by connecting a resistor from this pin to ground. The Applications Information section of the data sheet includes a table to determine the resistance value based on the desired switching frequency. Minimize capacitance at this pin.

SHARE (Pin F7): Tie this to the SHARE pin of another LTM8023 when paralleling the outputs. Otherwise, do not connect (leave floating).
SYNC (Pin G6): This is the external clock synchronization input. Ground this pin for low ripple BurstMode ${ }^{\circledR}$ operation at low output loads. Tie to a stable voltage source greater than 0.7V to disable Burst Mode operation. Do not leave this pin floating. Tie to a clock source for synchronization. Clock edges should have rise and fall times faster than $1 \mu \mathrm{~s}$. See synchronizing section in Applications Information.
PGOOD (Pin H6): The PGOOD pin is the open-collector output of an internal comparator. PG remains low until the ADJ pin is within $10 \%$ of the final regulation voltage. PG output is valid when $\mathrm{V}_{\text {IN }}$ is above 3.6 V and RUN/SS is high. If this function is not used, leave this pin floating.

ADJ (Pin H7): The LTM8023 regulates its ADJ pin to 0.79V. Connect the adjust resistor from this pin to ground. The value of $R_{\text {ADJ }}$ is given by the equation $R_{\text {ADJ }}=394.21 /$ $\left(V_{\text {OUT }}-0.79\right)$, where $R_{A D J}$ is in $k \Omega$.

## LTM8023

## BLOCK DIAGRAM



## OPERATION

The LTM8023 is a standalone nonisolated step-down switching DC/DC power supply. It can deliver up to 2 A of DC output current with only bulk external input and output capacitors. This module provides a precisely regulated output voltage programmable via one external resistor from $0.8 \mathrm{~V}_{\mathrm{DC}}$ to $10 \mathrm{~V}_{\mathrm{DC}}$. The input voltage range is 3.6 V to 36 V . Given that the LTM8023 is a step-down converter, make sure that the input voltage is high enough to support the desired output voltage and load current. A simplified Block Diagram is given on the previous page.
The LTM8023 contains a current mode controller, power switching element, power inductor, power Schottky diode and a modest amount of input and output capacitance.
The LTM8023 is a fixed frequency PWM regulator. The switching frequency is set by simply connecting the appropriate resistor value from the $R_{\top}$ pin to GND.

An internal regulator provides power to the control circuitry. The bias regulator normally draws power from the $\mathrm{V}_{\text {IN }}$ pin, but if the BIAS pin is connected to an external
voltage higher than 2.8 V , bias power will be drawn from the external source (typically the regulated output voltage). This improves efficiency. The RUN/SS pin is used to place the LTM8023 in shutdown, disconnecting the output and reducing the input current to less than $1 \mu \mathrm{~A}$.
To further optimize efficiency, the LTM8023 automatically switches to Burst Mode operation in light load situations. Between bursts, all circuitry associated with controlling the output switch is shut down reducing the input supply current to $50 \mu \mathrm{~A}$ in a typical application. The oscillator reduces the LTM8023's operating frequency when the voltage atthe ADJ pin is low. This frequency foldback helps to control the output current during start-up and overload.

The LTM8023 contains a power good comparator which trips when the ADJ pin is at $92 \%$ of its regulated value. The PGOOD output is an open-collector transistor that is off when the output is in regulation, allowing an external resistor to pull the PGOOD pin high. Power good is valid when the LTM8023 is enabled and $\mathrm{V}_{\mathbb{I}}$ is above 3.6 V .

## APPLICATIONS INFORMATION

For most applications, the design process is straight forward, summarized as follows:

1. Look at Table 1 and find the row that has the desired input range and output voltage.
2. Apply the recommended $C_{I N}, C_{O U T}, R_{A D J}$ and $R_{T}$ values.
3. Connect BIAS as indicated.

While these component combinations have been tested for proper operation, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

## Capacitor Selection Considerations

The $\mathrm{C}_{\mathrm{IN}}$ and $\mathrm{C}_{\text {OUt }}$ capacitor values in Table 1 are the minimum recommended values for the associated operating conditions. Applying capacitor values below those
indicated in Table 1 is not recommended, and may result in undesirable operation. Using larger values is generally acceptable, and can yield improved dynamic response, if it is necessary. Again, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Ceramic capacitors are small, robust and have very low ESR. However, not all ceramic capacitors are suitable. X5R and X7R types are stable over temperature and applied voltage and give dependable service. Other types, including Y 5 V and $\mathrm{Z5U}$ have very large temperature and voltage coefficients of capacitance. In an application circuit they may have only a small fraction of their nominal capacitance resulting in much higher output voltage ripple than expected.

## APPLICATIONS INFORMATION

Table 1．Recommended Component Values and Configuration（ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ）

| $V_{\text {IN }}$ | $\mathrm{V}_{\text {OUT }}$ | $\mathrm{CIN}_{\text {IN }}$ | $\mathrm{C}_{\text {OUT }}$ | $\mathrm{R}_{\text {ADJ }}$ | BIAS | $\mathrm{f}_{\text {OPTIMAL }}(\mathrm{kHz}$ ） | $\mathrm{R}_{\mathrm{T} \text {（OPTIMAL）}}$ | $\mathrm{f}_{\text {MaX }}(\mathrm{kHz}$ ） | $\mathrm{R}_{\text {T（MIN）}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 3.6 V to 36 V | 0.82 V | 10¢F | 2004F 1206 | 13M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 250 | 150k | 250 | 150k |
| 3.6 V to 36V | 1.00 V | 10＾F | 147 $\mu \mathrm{F} 1206$ | 1．87M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 300 | 124k | 300 | 124k |
| 3.6 V to 36 V | 1.20 V | 10¢F | 1004F 1206 | 953k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 350 | 105k | 350 | 105k |
| 3.6 V to 36V | 1.50 V | 10山F | 100 F F 1206 | 549k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 400 | 88．7k | 400 | 88．7k |
| 3.6 V to 36 V | 1.80 V | 4．7 $\mu \mathrm{F}$ | 1004F 1206 | 383k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 450 | 79k |
| 3.6 V to 36 V | 2.00 V | $2.2 \mu \mathrm{~F}$ | 68 $\mu \mathrm{F} 1206$ | 324k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 500 | 69．8k |
| 3.6 V to 36 V | 2.20 V | $2.2 \mu \mathrm{~F}$ | 47 F 1206 | 274k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 500 | 69．8k | 550 | 61．9k |
| 4.1 V to 36V | 2.50 V | $2.2 \mu \mathrm{~F}$ | 47 H 1206 | 226k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 550 | 61．9k | 615 | 54．9k |
| 5.5 V to 36 V | 3.30 V | $2.2 \mu \mathrm{~F}$ | $22 \mu \mathrm{~F} 1206$ | 154k | AUX | 650 | 49．9k | 750 | 42．2k |
| 7.5 V to 36 V | 5.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 93．1k | AUX | 650 | 49．9k | 890 | 34．8k |
| 3.6 V to 15V | 0.82 V | 10¢F | 200＾F 1206 | 13M | VIN | 350 | 105k | 650 | 49．9k |
| 3.6 V to 15V | 1.00 V | 10¢F | 147 F F 1206 | 1．87M | $\mathrm{V}_{\text {IN }}$ | 400 | 88．7k | 725 | 43．2k |
| 3.6 V to 15V | 1.20 V | 10¢F | 1004F 1206 | 953k | $\mathrm{V}_{\text {IN }}$ | 450 | 79k | 800 | 39．2k |
| 3.6 V to 15V | 1.50 V | 10ヶF | 100 F F 1206 | 549k | $\mathrm{V}_{\text {IN }}$ | 450 | 79k | 1000 | 29．4k |
| 3.6 V to 15V | 1.80 V | 4．7 $\mu \mathrm{F}$ | 100＾F 1206 | 383k | $\mathrm{V}_{\text {IN }}$ | 450 | 79k | 1100 | 26．7k |
| 3.6 V to 15V | 2.00 V | $2.2 \mu \mathrm{~F}$ | 684F 1206 | 324k | $\mathrm{V}_{\text {IN }}$ | 450 | 79k | 1200 | 23．7k |
| 3.6 V to 15V | 2.20 V | $2.2 \mu \mathrm{~F}$ | 47 F 1206 | 274k | $\mathrm{V}_{\text {IN }}$ | 500 | 69．8k | 1300 | 21．0k |
| 3.6 V to 15V | 2.50 V | $2.2 \mu \mathrm{~F}$ | 47 $\mu \mathrm{F} 1206$ | 226k | $\mathrm{V}_{\text {IN }}$ | 550 | 61．9k | 1450 | 18．2k |
| 5.5 V to 15V | 3.30 V | $2.2 \mu \mathrm{~F}$ | $22 \mu \mathrm{~F} 1206$ | 154k | AUX | 650 | 49．9k | 1400 | 19．6k |
| 7.5 V to 15V | 5.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 93．1k | AUX | 650 | 49．9k | 1200 | 23．7k |
| 9 V to 24 V | 0.82 V | 10んF | 2004F 1206 | 13M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 250 | 150k | 250 | 150k |
| 9 V to 24 V | 1.00 V | 10ヶF | 147 $\mu \mathrm{F} 1206$ | 1．87M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 300 | 124k | 450 | 79k |
| 9 V to 24 V | 1.20 V | $2.2 \mu \mathrm{~F}$ | 100＾F 1206 | 953k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 500 | 69．8k |
| 9 V to 24 V | 1.50 V | $2.2 \mu \mathrm{~F}$ | 100） 1206 | 549k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 615 | 54．9k |
| 9 V to 24 V | 1.80 V | $2.2 \mu \mathrm{~F}$ | 100＾F 1206 | 383k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 700 | 44．2k |
| 9 V to 24 V | 2.00 V | $2.2 \mu \mathrm{~F}$ | $68 \mu \mathrm{~F} 1206$ | 324k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 750 | 42．2k |
| 9 V to 24 V | 2.20 V | $2.2 \mu \mathrm{~F}$ | 47 F 1206 | 274k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 500 | 69．8k | 800 | 39．2k |
| 9 V to 24 V | 2.50 V | $2.2 \mu \mathrm{~F}$ | 47 $\mu \mathrm{F} 1206$ | 226k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 550 | 61．9k | 890 | 34．8k |
| 9 V to 24 V | 3.30 V | $2.2 \mu \mathrm{~F}$ | $22 \mu \mathrm{~F} 1206$ | 154k | AUX | 650 | 49．9k | 1150 | 25．5k |
| 9 V to 24 V | 5.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 93．1k | AUX | 650 | 49．9k | 1000 | 29．4k |
| 14.5 V to 24 V | 8.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 53．6k | AUX | 650 | 49．9k | 800 | 39．2k |
| 18 V to 36 V | 0.82 V | 10ヶF | 200） 1206 | 13M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 250 | 150k | 250 | 150k |
| 18 V to 36 V | 1.00 V | 10¢F | 147 F F 1206 | 1．87M | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 300 | 124k | 300 | 124k |
| 18 V to 36 V | 1.20 V | $2.2 \mu \mathrm{~F}$ | 100 FF 1206 | 953k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 350 | 105k | 350 | 105k |
| 18 V to 36 V | 1.50 V | $2.2 \mu \mathrm{~F}$ | 100＾F 1206 | 549k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 400 | 88．7k | 400 | 88．7k |
| 18 V to 36 V | 1.80 V | $2.2 \mu \mathrm{~F}$ | 100 FF 1206 | 383k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 450 | 79k |
| 18 V to 36 V | 2.00 V | $2.2 \mu \mathrm{~F}$ | 68 F F 1206 | 324k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 500 | 69．8k |
| 18 V to 36 V | 2.20 V | $2.2 \mu \mathrm{~F}$ | 47 H 1206 | 274k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 450 | 79k | 550 | 61．9k |
| 18 V to 36 V | 2.50 V | $2.2 \mu \mathrm{~F}$ | 47 F 1206 | 226k | $\geq 2.8 \mathrm{~V},<16 \mathrm{~V}$ | 500 | 69．8k | 615 | 54．9k |
| 18 V to 36 V | 3.30 V | $2.2 \mu \mathrm{~F}$ | $22 \mu \mathrm{~F} 1206$ | 154k | AUX | 650 | 49．9k | 750 | 42．2k |
| 18 V to 36 V | 5.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 93．1k | AUX | 800 | 39．2k | 890 | 34．8k |
| 18 V to 36 V | 8.00 V | $2.2 \mu \mathrm{~F}$ | 10¢F 0805 | 53．6k | AUX | 650 | 49．9k | 800 | 39．2k |
| 20 V to 36 V | 10.00 V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 42．2k | AUX | 615 | 54．9k | 750 | 42．2k |
| 4.75 V to 32V | －3．30V | $2.2 \mu \mathrm{~F}$ | $22 \mu \mathrm{~F} 1206$ | 154k | AUX | 550 | 61．9k | 800 | 39．2k |
| 7 V to 31V | －5．00V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 93．1k | AUX | 800 | 39．2k | 1100 | 26．7k |
| 15 V to 28 V | －8．00V | $2.2 \mu \mathrm{~F}$ | 10ヶF 0805 | 53．6k | AUX | 800 | 39．2k | 1600 | 15．8k |

A bulk input capacitor is required．

## APPLICATIONS INFORMATION

Ceramic capacitors are also piezoelectric. In Burst Mode operation, the LTM8023's switching frequency depends on the load current, and can excite a ceramic capacitor at audio frequencies, generating audible noise. Since the LTM8023 operates at a lower current limit during Burst Mode operation, the noise is typically very quiet to a casual ear.
If this audible noise is unacceptable, use a high performance electrolytic capacitor at the output. The input capacitor can be a parallel combination of a $2.2 \mu \mathrm{~F}$ ceramic capacitor and a low cost electrolytic capacitor.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LTM8023. A ceramic input capacitor combined with trace or cable inductance forms a high $Q$ (under damped) tank circuit. If the LTM8023 circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the device's rating. This situation is easily avoided; see the Hot-Plugging Safely section.

## Frequency Selection

The LTM8023 uses a constant frequency PWM architecture that can be programmed to switch from 200 kHz to 2.4 MHz by using a resistor tied from the $\mathrm{R}_{\top}$ pin to ground. Table 2 provides a list of $R_{\top}$ resistor values and their resultant frequencies.

Table 2. Switching Frequency vs $\mathbf{R}_{\mathrm{T}}$ Value

| SWITCHING FREQUENCY (MHz) | $\mathbf{R}_{\mathbf{T}}$ VALUE $(\mathbf{k} \Omega)$ |
| :---: | :---: |
| 0.2 | 187 |
| 0.3 | 124 |
| 0.4 | 88.7 |
| 0.5 | 69.8 |
| 0.6 | 56.2 |
| 0.7 | 46.4 |
| 0.8 | 39.2 |
| 0.9 | 34.6 |
| 1.0 | 29.4 |
| 1.2 | 23.7 |
| 1.4 | 19.6 |
| 1.6 | 15.8 |
| 1.8 | 13.3 |
| 2.0 | 11.5 |
| 2.2 | 9.76 |
| 2.4 | 8.66 |

## Operating Frequency Trade-Offs

It is recommended that the user apply the optimal $\mathrm{R}_{\boldsymbol{T}}$ value given in Table 1 for the input and output operating condition. System level or other considerations, however, may necessitate another operating frequency. While the LTM8023 is flexible enough to accommodate a wide range of operating frequencies, a haphazardly chosen one may result in undesirable operation under certain operating or fault conditions. A frequency that is too high can reduce efficiency, generate excessive heat or even damage the LTM8023 if the output is overloaded or short circuited. A frequency that is too low can result in a final design that has too much output ripple or too large of an output capacitor.
The maximum frequency (and attendant $\mathrm{R}_{T}$ value) at which the LTM8023 should be allowed to switch is given in Table 1 in the $f_{(\text {MAX })}$ column, while the recommended frequency (and $\mathrm{R}_{\top}$ value) for optimal efficiency over the given input condition is given in the $f_{O P T I M A L}$ column.
There are additional conditions that must be satisfied if the synchronization function is used. Please refer to the Synchronization section for details.

## BIAS Pin Considerations

The BIAS pin is used to provide drive power for the internal power switching stage and operate internal circuitry. For proper operation, it must be powered by at least 2.8 V . If the output voltage is programmed to be 2.8 V or higher, simply tie BIAS to $\mathrm{V}_{\text {OUT }}$. If $\mathrm{V}_{\text {OUT }}$ is less than 2.8 V , BIAS can be tied to $\mathrm{V}_{\mathrm{IN}}$ or some other voltage source. In all cases, ensure that the maximum voltage at the BIAS pin is both less than 16 V and the sum of $\mathrm{V}_{\text {IN }}$ and BIAS is less than 56 V . If BIAS power is applied from a remote or noisy voltage source, it may be necessary to apply a decoupling capacitor locally to the LTM8023.

## APPLICATIONS InFORMATION

## Load Sharing

Two or more LTM8023's may be paralleled to produce higher currents. To do this, tie the $\mathrm{V}_{\text {IN }}, A D J, \mathrm{~V}_{\text {OUT }}$ and SHARE pins of all the paralleled LTM8023's together. To ensure that paralleled modules start up together, the RUN/ SS pins may be tied together, as well. If the RUN/SS pins are not tied together, make sure that the same valued softstart capacitors are used for each module. An example of two LTM8023 modules configured for load sharing is given in the Typical Applications section.
For currentsharing applications using multiple LTM8023s, the ADJ pins for all regulators may be combined using one resistor to ground as determined by:

$$
\mathrm{R}_{\text {ADJ }}=\frac{\frac{394.21}{N}}{V_{\text {OUT }}-0.79}
$$

where N is the number of paralleled modules and $\mathrm{R}_{\text {ADJ }}$ is in $\mathrm{k} \Omega$.

## Burst Mode Operation

To enhance efficiency at light loads, the LTM8023 automatically switches to Burst Mode operation which keeps the output capacitor charged to the proper voltage while minimizing the input quiescentcurrent. During BurstMode operation, the LTM8023 delivers single cycle bursts of current to the output capacitor followed by sleep periods where the output power is delivered to the load by the output capacitor. In addition, $\mathrm{V}_{\mathrm{IN}}$ and BIAS quiescent currents are reduced to typically $25 \mu \mathrm{~A}$ and $50 \mu \mathrm{~A}$ respectively during the sleep time. As the load current decreases towards a no Ioad condition, the percentage of time that the LTM8023 operates in sleep mode increases and the average input current is greatly reduced, resulting in higher efficiency.
Burst Mode operation is enabled by tying SYNC to GND. To disable Burst Mode operation, tie SYNC to a stable voltage above 0.7 V or synchronize to an external clock. Do not leave the SYNC pin floating.

## Minimum Input Voltage

The LTM8023 is a step-down converter, so a minimum amount of headroom is required to keep the output in regulation. In addition, the input voltage required to turn on is higher than that required to run, and depends upon whether the RUN/SS is used. As shown in Figure 2, it takes only about 3.5 V IN for the LTM8023 to run a 3.3 V output at light load. If RUN/SS is tied to $\mathrm{V}_{\mathrm{IN}}$, a 5.5 V input voltage is required to start. If $\mathrm{V}_{\text {IN }}$ is allowed to settle in the operating region first then the RUN/SS pin is enabled, the minimum input voltage to start at light load is lower, about 4.2 V . A similar curve for 5 V Out operation is also provided in Figure 2.


Figure 2. The LTM8023 Needs More Voltage to Start Than to Run

APPLICATIONS INFORMATION

## Soft-Start

The RUN/SS pin can be used to soft-start the LTM8023, reducing the maximum input current during start-up. The RUN/SS pin is driven through an external RC filter to create a voltage ramp at this pin. Figure 3 shows the start-up and shutdown waveforms with the soft-start circuit. By choosing an appropriate RC time constant, the peak start-up current can be reduced to the current that is required to regulate the output, with no overshoot. Choose the value of the resistor so that it can supply at least $20 \mu \mathrm{~A}$ when the RUN/SS pin reaches 2.5 V .


Figure 3. To Soft-Start the LTM8023, Add a Resistor and Capacitor to the RUN/SS Pin

## Synchronization

The internal oscillator of the LTM8023 can be synchronized by applying an external 250 kHz to 2 MHz clock to the SYNC pin. Do not leave this pin floating. The resistortied from the $\mathrm{R}_{\top}$ pin to ground should be chosen such that the LTM8023 oscillates 20\% lower than the intended synchronization frequency (see the Frequency Selection section).
The LTM8023 will not enter Burst Mode operation while synchronized to an external clock, but will instead skip pulses to maintain regulation.

## Shorted Input Protection

Care needs to be taken in systems where the output will be held high when the input to the LTM8023 is absent. This may occur in battery charging applications or in battery backup systems where a battery or some other supply is diode OR-ed with the LTM8023's output. If the $\mathrm{V}_{\text {IN }}$ pin is allowed to float and the RUN/SS pin is held high (either by a logic signal or because it is tied to $\mathrm{V}_{\text {IN }}$ ), then the LTM8023's internal circuitry will pull its quiescent current through its internal power switch. This is fine if your system can tolerate a few milliamps in this state. If you ground the RUN/SS pin, the internal power switch current will drop to essentially zero. However, if the $\mathrm{V}_{\text {IN }}$ pin is grounded while the output is held high, then parasitic diodes inside the LTM8023 can pull large currents from the output through the $\mathrm{V}_{\text {IN }}$ pin. Figure 4 shows a circuit that will run only when the input voltage is present and that protects against a shorted or reversed input.


Figure 4. The Input Diode Prevents a Shorted Input from Discharging a Backup Battery Tied to the Output. It Also Protects the Circuit from a Reversed Input. The LTM8023 Runs Only When the Input is Present.

## APPLICATIONS INFORMATION

## PCB Layout

Most of the headaches associated with PCB layout have been alleviated or even eliminated by the high level of integration of the LTM8023. The LTM8023 is nevertheless a switching power supply, and care must be taken to minimize EMI and ensure proper operation. Even with the high level of integration, you may fail to achieve specified operation with a haphazard or poor layout. See Figure 5 for a suggested layout.


Figure 5. Layout Showing Suggested External Components, GND Plane and Thermal Vias

Ensure that the grounding and heatsinking are acceptable. A few rules to keep in mind are:

1. Place the $R_{A D J}$ and $R_{T}$ resistors as close as possible to their respective pins.
2. Place the $\mathrm{C}_{\text {IN }}$ capacitor as close as possible to the $\mathrm{V}_{\text {IN }}$ and GND connection of the LTM8023.
3. Place the Cout capacitor as close as possible to the $V_{\text {OUT }}$ and GND connection of the LTM8023.
4. Place the $\mathrm{C}_{\mathrm{IN}}$ and $\mathrm{C}_{\text {OUt }}$ capacitors such that their ground current flow directly adjacent or underneath the LTM8023.
5. Connect all of the GND connections to as large a copper pour or plane area as possible on the top layer. Avoid breaking the ground connection between the external components and the LTM8023.
6. Use vias to connect the GND copper area to the boards internal ground plane. Liberally distribute these GND vias to provide both a good ground connection and thermal path to the internal planes of the printed circuit board.

## Hot-Plugging Safely

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the input bypass capacitor of LTM8023. However, these capacitors can cause problems if the LTM8023 is plugged into a live supply (see Linear Technology Application Note 88 for a complete discussion). The low loss ceramic capacitor combined with stray inductance in series with the power source forms an underdamped tank circuit, and the voltage at the $\mathrm{V}_{\text {IN }}$ pin of the LTM8023 can ring to twice the nominal input voltage, possibly exceeding the LTM8023's rating and damaging the part. If the input supply is poorly controlled or the user will be plugging the LTM8023 into an energized supply, the input network should be designed to prevent this overshoot. Figure 6 shows the waveforms that result when an LTM8023 circuit is connected to a 24 V supply through six feet of 24 -gauge twisted pair. The first plot is the response with a $2.2 \mu \mathrm{~F}$ ceramic capacitor at the input. The input voltage rings as high as 35 V and the input current peaks at 20A. One method of damping the tank circuit is to add another capacitor with a series resistor to the circuit. In Figure 6c an aluminum electrolytic capacitor has been added. This capacitor's high equivalent series resistance damps the circuit and eliminates the voltage overshoot. The extra capacitor improves low frequency

## APPLICATIONS INFORMATION



Figure 6. A Well Chosen Input Network Prevents Input Voltage Overshoot and Ensures Reliable Operation When the LTM8023 is Connected to a Live Supply
ripple filtering and can slightly improve the efficiency of the circuit, though it is likely to be the largest component in the circuit. An alternative solution is shown in Figure 6b. A0.7 resistor is added in series with the input to eliminate the voltage overshoot (it also reduces the peak input current).

A $0.1 \mu \mathrm{~F}$ capacitor improves high frequency filtering. This solution is smaller and less expensive than the electrolytic capacitor. For high input voltages its impact on efficiency is minor, reducing efficiency less than one-half percent for a 5 V output at full load operating from 24 V .

## APPLICATIONS InFORMATION

## Thermal Considerations

The LTM8023 output current may need to be derated if it is required to operate in a high ambient temperature or deliver a large amount of continuous power. The amount of current derating is dependent upon the input voltage, output power and ambient temperature. The temperature rise curves given in the Typical Performance Characteristics section can be used as a guide. These curves were generated by an LTM8023 mounted to a $33 \mathrm{~cm}^{2} 4$-layerFR4 printed circuit board. Boards of other sizes and layer count can exhibit different thermal behavior, so it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental operating conditions.

The thermal resistance numbers listed in the Pin Configuration are based on modeling the $\mu$ Module package mounted on a test board specified per JESD51-9 "Test Boards for Area Array Surface Mount Package Thermal Measurements." The thermal coefficients provided in this page are based on JESD 51-12 "Guidelines for Reporting and Using Electronic Package Thermal Information."

For increased accuracy and fidelity to the actual application, many designers use FEA to predict thermal performance. To that end, the Pin Configuration typically gives four thermal coefficients:

- $\theta_{\mathrm{JA}}$ - Thermal resistance from junction to ambient.
- $\theta_{\text {JCbottom }}$ - Thermal resistance from junction to the bottom of the product case.
- $\theta_{\text {Jctop }}$ - Thermal resistance from junction to top of the product case.
- $\theta_{\mathrm{JB}}$ - Thermal resistance from junction to the printed circuit board.

While the meaning of each of these coefficients may seem to be intuitive, JEDEC has defined each to avoid confusion and inconsistency. These definitions are given in JESD51-12, and are quoted or paraphrased in the following:

- $\theta_{\mathrm{JA}}$ is the natural convection junction-to-ambient air thermal resistance measured in a one cubic foot sealed enclosure. This environment is sometimes referred to as
"still air" although natural convection causes the air to move. This value is determined with the part mounted to a JESD 51-9 defined test board, which does not reflect an actual application or viable operating condition.
- $\theta_{\text {Jcbottom }}$ is the junction-to-board thermal resistance with all of the component power dissipation flowing through the bottom of the package. In the typical $\mu$ Module regulator, the bulk of the heat flows out the bottom of the package, but there is always heat flow out into the ambient environment. As a result, this thermal resistance value may be useful for comparing packages but the test conditions don't generally match the user's application.
- $\theta_{\text {JCtop }}$ is determined with nearly all of the component power dissipation flowing through the top of the package. As the electrical connections of the typical $\mu$ Module regulator are on the bottom of the package, it is rare for an application to operate such that most of the heat flows from the junction to the top of the part. As in the case of $\theta_{\text {JCbottom }}$, this value may be useful for comparing packages but the test conditions don't generally match the user's application.
- $\theta_{\mathrm{JB}}$ is the junction-to-board thermal resistance where almost all of the heat flows through the bottom of the $\mu$ Module regulator and into the board, and is really the sum of the $\theta_{\text {Jcbottom }}$ and the thermal resistance of the bottom of the part through the solder joints and through a portion of the board. The board temperature is measured a specified distance from the package, using a two sided, two layer board. This board is described in JESD 51-9.

The most appropriate way to use the coefficients is when running a detailed thermal analysis, such as FEA, which considers all of the thermal resistances simultaneously. None of them can be individually used to accurately predict the thermal performance of the product, so it would be inappropriate to attempt to use any one coefficient to correlate to the junction temperature versus load graphs given in the LTM8023 data sheet.

## APPLICATIONS INFORMATION

A graphical representation of these thermal resistances is given in Figure 7.
The blue resistances are contained within the $\mu$ Module regulator, and the green are outside.

The die temperature of the LTM8023 must be lower than the maximum rating of $125^{\circ} \mathrm{C}$, so care should be taken in the layout of the circuit to ensure good heat sinking of the LTM8023. The bulk of the heat flow out of the LTM8023 is through the bottom of the module and the LGA
pads into the printed circuit board. Consequently a poor printed circuit board design can cause excessive heating, resulting in impaired performance or reliability. Please refer to the PCB Layout section for printed circuit board design suggestions.
Finally, be aware that at high ambient temperatures the internal Schottky diode will have significantleakage current increasing the quiescent current of the LTM8023.


Figure 7

## TYPICAL APPLICATIONS



*RUNNING VOLTAGE RANGE. PLEASE REFER TO APPLICATIONS INFORMATION FOR START-UP DETAILS



FOR START-UP DETAILS
2.5V Step-Down Converter


TYPICAL APPLICATIONS
-5V Positive to Negative Converter

-5V Positive to Negative Converter Load Current vs Input Voltage


Two LTM8023's in Parallel, 3.3V at 4A


## LTM8023

PACKAGE DESCRIPTION
Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.




| NOTES <br> 1. DIMENS <br> 2. ALL DIM | onng and to ENSIONS ARE |
| :---: | :---: |
| 3 Land | designation |
| 4 DETALLS OF PAD \#1 IDENTIFER ARE OPTIONAL icated THE PAD \#1 IDENTIFER MAY BE ETTHER A MOLD OR A FEATUBE |  |
|  |  |
| 5. PRIIMARY Datum z-IIS Seating plane |  |
| 6. THE TOTAL Lumber of pads: 50 |  |
| PACKAGE ROW AND COLUMN LABELING MAY VARY AMONG $\mu$ Module PRODUCTS. REVIEW EACH PACKAGE |  |
|  |  |
| ssmbol | Tolerance |
| aаa | 0.15 |
| bbb | 0.10 |




## PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.


BGA Package
50 -Lead (11.25mm $\times 9.00 \mathrm{~mm} \times 3.42 \mathrm{~mm})$
$($ Reference LTC DWG $\# 05-08-1883$ Rev A)




## LTM8023

## PACKAGE DESCRIPTION

Table 3. Pin Assignment (Sorted by Pin Number)

| PIN | SIGNAL DESCRIPTION | PIN | SIGNAL DESCRIPTION |
| :---: | :---: | :---: | :---: |
| A1 | V OUT | D5 | GND |
| A2 | $V_{\text {OUT }}$ | D6 | GND |
| A3 | $V_{\text {OUT }}$ | D7 | GND |
| A4 | $V_{\text {OUT }}$ | E1 | GND |
| A5 | GND | E2 | GND |
| A6 | GND | E3 | GND |
| A7 | GND | E4 | GND |
| B1 | $V_{\text {OUT }}$ | E5 | GND |
| B2 | $V_{\text {OUT }}$ | E6 | GND |
| B3 | $V_{\text {OUT }}$ | E7 | GND |
| B4 | $V_{\text {OUT }}$ | F5 | AUX |
| B5 | GND | F6 | GND |
| B6 | GND | F7 | SHARE |
| B7 | GND | G1 | VIN |
| C1 | $V_{\text {OUT }}$ | G2 | $\mathrm{V}_{\text {IN }}$ |
| C2 | $\mathrm{V}_{\text {OUT }}$ | G3 | $\mathrm{V}_{\text {IN }}$ |
| C3 | $\mathrm{V}_{\text {OUT }}$ | G5 | BIAS |
| C4 | $\mathrm{V}_{\text {OUT }}$ | G6 | SYNC |
| C5 | GND | G7 | $\mathrm{R}_{\mathrm{T}}$ |
| C6 | GND | H1 | $\mathrm{V}_{\text {IN }}$ |
| C7 | GND | H2 | VIN |
| D1 | GND | H3 | VIN |
| D2 | GND | H5 | RUN/SS |
| D3 | GND | H6 | PGOOD |
| D4 | GND | H7 | ADJ |

## $\boldsymbol{R} \in$ VISIOC HISTORY (Revision history begins at Rev $F$ )

| REV | DATE | DESCRIPTION | PAGE NUMBER |
| :---: | :---: | :--- | :---: |
| F | $8 / 10$ | Added Note 5 | 3 |
| G | $8 / 11$ | Added BGA package. Changes reflected throughout the data sheet. | 1 to 24 |
| H | $8 / 13$ | Changed output capacitor from 2.2 2 F to $22 \mu \mathrm{~F}$ | 1 |
| I | $2 / 14$ | Added SnPb BGA package option | 1,2 |
| J | $8 / 15$ | Updated thermal impedance values | 2 |

## PACKAGE PHOTOGRAPHS

## LGA



## BGA



## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LTM8022 | 36V, 1A Step-Down $\mu$ Module Regulator | $0.8 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 10 \mathrm{~V}$, Synchronizable, $9 \mathrm{~mm} \times 11.25 \mathrm{~mm} \times 2.8 \mathrm{~mm}$ LGA |
| LTM8025 | 36V, 3A Step-Down $\mu$ Module Regulator | $0.8 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 24 \mathrm{~V}$, Synchronizable, $9 \mathrm{~mm} \times 15 \mathrm{~mm} \times 4.3 \mathrm{~mm}$ LGA |
| LTM8027 | 60V, 4A Step-Down $\mu$ Module Regulator | $2.5 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 24 \mathrm{~V}$, Synchronizable, $15 \mathrm{~mm} \times 15 \mathrm{~mm} \times 4.3 \mathrm{~mm}$ LGA |
| LTM4612 | EN55022B Certified 36V, 5A Step-Down $\mu$ Module Regulator | $3.3 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 15 \mathrm{~V}$, Synchronizable, $15 \mathrm{~mm} \times 15 \mathrm{~mm} \times 2.8 \mathrm{~mm}$ LGA |
| LTM4613 | EN55022B Certified 36V, 8A Step-Down $\mu$ Module Regulator | $3.3 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 15 \mathrm{~V}$, Synchronizable, $15 \mathrm{~mm} \times 15 \mathrm{~mm} \times 4.3 \mathrm{~mm}$ LGA |
| LTM8061 | 32V, 2A Li-Ion/Li-Polymer $\mu$ Module Battery Charger | C/10 or Timer Termination, Auto-Recharge, Programmable Charge Current, $9 \mathrm{~mm} \times 15 \mathrm{~mm} \times 4.3 \mathrm{~mm}$ LGA |

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Switching Voltage Regulators category:
Click to view products by Analog Devices manufacturer:
Other Similar products are found below :
TLF30682QVS01XUMA1 TPSM84209RKHR FAN53526UC106X FAN53526UC128X MP1587EN-LF FAN48610BUC33X FAN48617UC50X FAN53526UC89X MIC45116-1YMP-T1 NCV891234MW50R2G EN2342QI AST1S31PUR 16017 A6986FTR NCP81103MNTXG NCP81203PMNTXG MAX17242ETPA+ MAX16935RATEB/V+ MP2313GJ-Z NCP81208MNTXG MP8759GD-Z FAN53526UC100X FAN53526UC84X PCA9412AUKZ MP2314SGJ-Z AS1340A-BTDM-10 MP3421GG-P NCP81109GMNTXG MP6003DN-LF-Z MAX16935BAUES/V+ LT8315IFE\#PBF SCY1751FCCT1G NCP81109JMNTXG MAX16956AUBA/V+ AP3409ADNTR-G1 FAN48623UC36FX MPQ2454GH MPQ2454GH-AEC1 MP21148GQD-P AS3701B-BWLM-68 MPQ2143DJ-P MP9942AGJ-P MP8759GD-P MP5610GQG-P MP28200GG-P MP2451DJ-LF-Z MP2326GD-P MP2314SGJ-P MP2158AGQH-P MP2148GQD-18-P

